

PART LIST

LOGIC

No.	SPECIFICATION	Q'TY	LOCATION	VENDOR	REMARK
1	PCB,양면,HCF3000,LOGIC,REV 0	1		우성	
2	LCD	1	LCD1	SS HK	
3	IC,S3P9228,OTP,SOP	1	U3	SAMSUNG	
4	IC,24C02,EEPROM,2.7V,SOP	1	U4	ATMEL	
5	IC,RN5RK361A,D-D CONVERTER,SOP	1	U5	RICOH	
6	IC,R3111Q111A,SOP,VD	1	U6	RICOH	
7	TR,CHIP,KTA1505Y	2	Q1,Q3	KEC	
8	DIODE,CHIP,RB411D	1	D2	ROHM	
9	DIODE,CHIP,KDS181	1	D4	KEC	
10	CHIP LED SIDE VIEW, HT-110YG-CT	1	LED2	Para-light	
11	X-TAL,32.768Khz	1	X2	퀴즈텍	
12	SWITCH,TACT, 2.5mm SMD	2	SW1,SW2	코리아나	
13	COIL,CHOCK,100uH,BK,AX,LA36-101K	1	L7	광성	
14	RES,CHIP,472,J,1608,1/16W	2	R23,R24	FILKOR	
15	RES,CHIP,474,J,1608,1/16W	9	R15,R16,R17,R18,R19,R20,R22,R45, R46	FILKOR	
16	RES,CHIP,561,J,1608,1/16W	1	R43	FILKOR	
17	CAP,CHIP,104,Z,1608,50V/Y5V	2	C29,C32	SAMSUNG	
18	CAP,CHIP,120,J,1608,50V/COG	2	C26,C27	SAMSUNG	
19	CAP,CHIP,334,Z,1608,50V/Y5V	1	C28	SAMSUNG	
20	CAP,TANTAL,10UF,A SIZE,6.3V	1	C31	DAEWOO	
21	CAP,TANTAL,33UF,B SIZE,6.3V	1	C30	DAEWOO	
22	CONN' MAIL,6PIN	1	CON2	한일 일렉콤	
23	CONN' MAIL,3PIN	1	CON4	한일 일렉콤	

RF

No.	SPECIFICATION	Q'TY	LOCATION	VENDOR	REMARK
1	PCB,양면,HCF3000,RF,REV 0	1		우성	
2	IC,BH1415F,SOP	1	U1	ROHM	
3	TR,CHIP,2SD2142K	1	Q2	ROHM	
4	DIODE,VARICAP,KV1471E	1	D1	TOKO	
5	X-TAL,7.6Mhz	1	X1	퀴즈텍	
6	COIL,CHIP,FBEAD,1.2uH,1608	4	L1,L2,L5,L6	삼테크	
7	COIL,CHIP,68nH,LMC2012T-680J	1	L3	광성	
8	RES,CHIP,000,J,1608,1/16W	1	L4	FILKOR	
9	RES,CHIP,101,J,1608,1/16W	1	R11	FILKOR	
10	RES,CHIP,102,J,1608,1/16W	2	R10,R48	FILKOR	
11	RES,CHIP,103,J,1608,1/16W	2	R9,R12	FILKOR	
12	RES,CHIP,180,J,1608,1/16W	4	R1,R2,R6,R7	FILKOR	
13	RES,CHIP,203,J,1608,1/16W	1	R8	FILKOR	
14	RES,CHIP,224,J,1608,1/16W	1	R13	FILKOR	
15	RES,CHIP,474,J,1608,1/16W	3	R3,R4,R5	FILKOR	
16	CAP,CHIP,103,K,1608,50V/X7R	1	C22	SAMSUNG	
17	CAP,CHIP,104,Z,1608,50V/Y5V	6	C1,C2,C8,C13,C33,C53	SAMSUNG	
18	CAP,CHIP,105,Z,2012,50V/Y5V	2	C11,C34	SAMSUNG	
19	CAP,CHIP,120,J,1608,50V/COG	2	C26,C27	SAMSUNG	
20	CAP,CHIP,150,J,1608,50V/COG	1	C15	SAMSUNG	
21	CAP,CHIP,151,J,1608,50V/COG	3	C4,C10,C25	SAMSUNG	
22	CAP,CHIP,221,J,1608,50V/COG	1	C5	SAMSUNG	

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23	CAP,CHIP,330,J,1608,50V/COG	2	C6,C7	SAMSUNG	
24	CAP,CHIP,331,J,1608,50V/COG	1	C17	SAMSUNG	
25	CAP,CHIP,392,K,1608,50V/X7R	2	C3,C9	SAMSUNG	
26	CAP,CHIP,473,Z,1608,50V/Y5V	1	C19	SAMSUNG	
27	CAP,TANTAL,33UF,B SIZE,6.3V	1	C20	DAEWOO	
28	CAP,TANTAL,47UF,B SIZE,6.3V	1	C53	DAEWOO	
29	CONN' FEMAIL,6PIN	1	CON1	한일 일렉콤	
30	CONN' FEMAIL,3PIN	1	CON3	한일 일렉콤	
31	EAR-PHONE CURL-CORD, JACK 3.5pie	1		미진전자	

MECHANICAL

No.	SPECIFICATION	Q'TY	LOCATION	VENDOR	REMARK
1	BATTERY TERMINAL "+"	1		미래 정밀	
2	BATTERY TERMINAL "-"	1		서진 정공	
3	FRONT	1		도원 하이텍	
4	BACK	1		도원 하이텍	
5	BATTERY COVER ROCK KNOB	1		도원 하이텍	
6	BATTERY COVER	1		도원 하이텍	
7	LCD WINDOW	1		도원 하이텍	
8	KEY KNOB	1		도원 하이텍	
9	TOP PLATE	1		대화 인쇄	
10	NAME PLATE	1		대화 인쇄	
11	SCREW, MACHINE, BH) 2x6	2		성가 기업사	
12	BATTERY,1.5V	1	BATT	서통	

PACKING

No.	SPECIFICATION	Q'TY	LOCATION	VENDOR	REMARK
1	BLASTER	1		영진 인쇄사	
2	BOX, OUTER CARTON	1		영진 인쇄사	
3	PAD(PRINTED)	1		영진 인쇄사	